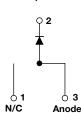
VS-HFA16TB120S-M3

Vishay Semiconductors

HEXFRED[®] Ultrafast Soft Recovery Diode, 16 A



www.vishay.com



PRIMARY CHARACTERISTICS						
I _{F(AV)}	16 A					
V _R	1200 V					
V _F at I _F	2.3 V					
t _{rr} (typ.)	30 ns					
T _J max.	150 °C					
Package	D ² PAK (TO-263AB)					
Circuit configuration	Single					

FEATURES

- Ultrafast and ultrasoft recovery
- Very low I_{RRM} and Q_{rr}
- Specified at operating conditions
- Meets MSL level 1, per J-STD-020, LF maximum FREE peak of 245 °C
- Designed and qualified for industrial level
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

BENEFITS

- Reduced RFI and EMI
- · Reduced power loss in diode and switching transistor
- Higher frequency operation
- Reduced snubbing
- Reduced parts count

DESCRIPTION

VS-HFA16TB120S is a state of the art ultrafast recovery diode. Employing the latest in epitaxial construction and advanced processing techniques it features a superb combination of characteristics which result in performance which is unsurpassed by any rectifier previously available. With basic ratings of 1200 V and 16 A continuous current, the VS-HFA16TB120S is especially well suited for use as the companion diode for IGBTs and MOSFETs. In addition to ultrafast recovery time, the HEXFRED® product line features extremely low values of peak recovery current (I_{BBM}) and does not exhibit any tendency to "snap-off" during the th portion of recovery. The HEXFRED features combine to offer designers a rectifier with lower noise and significantly lower switching losses in both the diode and the switching transistor. These HEXFRED advantages can help to significantly reduce snubbing, component count and heatsink sizes. The HEXFRED VS-HFA16TB120S is ideally suited for applications in power supplies and power conversion systems (such as inverters), motor drives, and many other similar applications where high speed, high efficiency is needed.

ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS			
Cathode to anode voltage	V _R		1200	V			
Maximum continuous forward current	١ _F	T _C = 100 °C	16				
Single pulse forward current	I _{FSM}		190	А			
Maximum repetitive forward current	I _{FRM}		64				
Maximum power dissipation	р	T _C = 25 °C	151	W			
Maximum power dissipation	PD	T _C = 100 °C	60	vv			
Operating junction and storage temperature range	T _J , T _{Stg}		-55 to +150	°C			

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Document Number: 96312



COMPLIANT





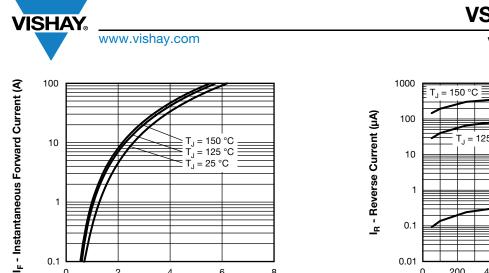
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ELECTRICAL SPECIFICATIONS (T_J = 25 °C unless otherwise specified)								
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS	
Cathode to anode breakdown voltage	V _{BR}	I _R = 100 μA		1200	-	-		
Maximum forward voltage	V _{FM}	I _F = 16 A	See fig. 1	-	2.5	3.0	V	
		I _F = 32 A		-	3.2	3.93		
		I _F = 16 A, T _J = 125 °C		-	2.3	2.7		
Maximum reverse	1	$V_{R} = V_{R}$ rated	See fig. 2	-	0.75	20		
leakage current	I _{RM}	$T_J = 125 \text{ °C}, V_R = 0.8 \text{ x } V_R \text{ rated}$	See lig. 2	-	375	2000	μA	
Junction capacitance	CT	V _R = 200 V See fig. 3		-	27	40	pF	
Series inductance	L _S	Measured lead to lead 5 mm from pa	ackage body	-	8.0	-	nH	

DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified)									
PARAMETER	SYMBOL	TEST CO	NDITIONS	MIN.	TYP.	MAX.	UNITS		
	t _{rr}	$I_F = 1.0 \text{ A}, \text{ d}I_F/\text{d}t = 200$	A/μs, V _R = 30 V	-	30	-			
Reverse recovery time See fig. 5 and 10	t _{rr1}	T _J = 25 °C		-	90	135	ns		
	t _{rr2}	T _J = 125 °C	I _F = 16 A dI _F /dt = 200 A/μs V _R = 200 V	-	164	245			
Peak recovery current	I _{RRM1}	T _J = 25 °C		-	5.8	10	А		
See fig. 6	I _{RRM2}	T _J = 125 °C		-	8.3	15	A		
Reverse recovery charge	Q _{rr1}	T _J = 25 °C		-	260	675	nC		
See fig. 7	Q _{rr2}	T _J = 125 °C		-	680	1838	no		
Peak rate of fall of recovery current during t _b See fig. 8	dl _{(rec)M} /dt1	T _J = 25 °C		-	120	-			
	dl _{(rec)M} /dt2	T _J = 125 °C		-	76	-	A/µs		

THERMAL - MECHANICAL SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS		
Lead temperature	T _{lead}	0.063" from case (1.6 mm) for 10 s	-	-	300	°C		
Thermal resistance, junction-to-case	R _{thJC}		-	-	0.83	K/W		
Thermal resistance, junction-to-ambient	R _{thJA}	Typical socket mount	-	-	80	r∨ vv		
Waight			-	2.0	-	g		
Weight			-	0.07	-	oz.		
Marking device		Case style D ² PAK (TO-263AB)		HFA16TB120S				



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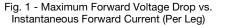
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4 V_{FM} - Forward Voltage Drop (V)

2

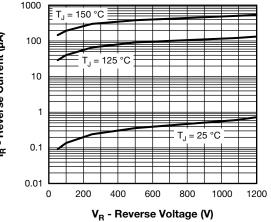
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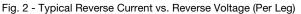
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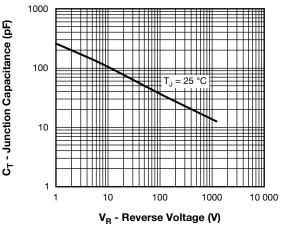


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

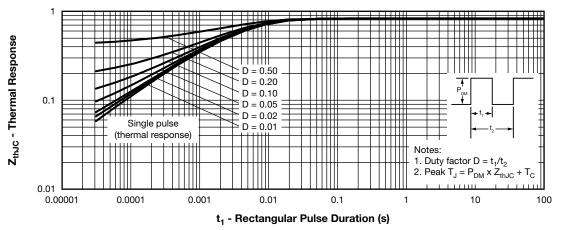
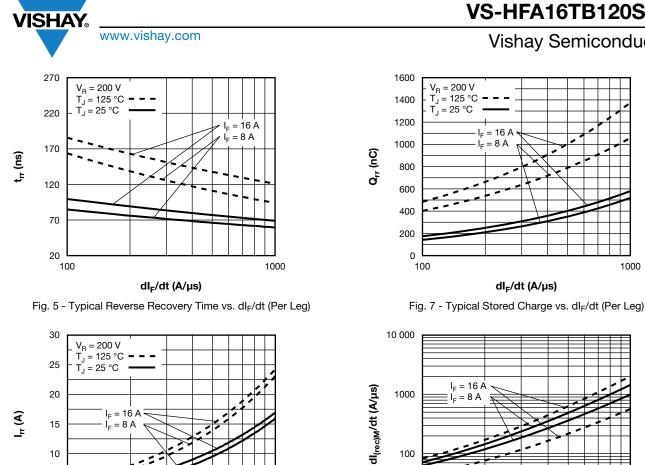


Fig. 4 - Maximum Thermal Impedance ZthJC Characteristics (Per Leg)



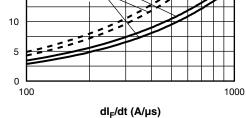
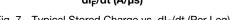


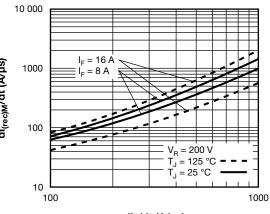
Fig. 6 - Typical Recovery Current vs. dl_F/dt (Per Leg)



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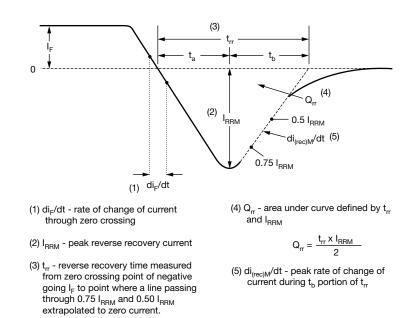
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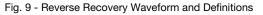




dl_F/dt (A/µs)







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ORDERING INFORMATION TABLE

Device code	VS-	HF	Α	16	тв	120	S	L	-M3
		(2)	(3)	(4)	(5)	6	(7)	(8)	(9)
	\bigcirc		\bigcirc	9	U	\bigcirc	0	\bigcirc	\bigcirc
	1	- Vis	hay Sen	niconduo	ctors pro	oduct			
	2	- HE	XFRED	[®] family					
	3	- Pro	cess de	signator	r: A = ele	ectron ir	radiate	d	
	4	- Cur	rent rati	ng (16 =	= 16 A)				
	5	- Pac	kage ou	utline (T	В = ТО-	220, 2 l	eads)		
	6	- Vol	tage rati	ing (120	= 1200	V)			
	7	- S=	D ² PAK	(TO-26	3AB)				
	8	• N	one = tu	lbe					
		• L	= tape a	and reel	(left orie	ented)			
		• R	= tape a	and reel	(right o	riented)			
	9	- Env	ironmer	ital digit:					
		-M3	= halog	jen-free,	, RoHS-	complia	nt, and	termina	tions le

ORDERING INFORMATION (Example)								
PREFERRED P/N	QUANTITY PER TUBE	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION					
VS-HFA16TB120S-M3	50	1000	Antistatic plastic tube					
VS-HFA16TB120SR-M3	800	800	13" diameter reel					
VS-HFA16TB120SL-M3	800	800	13" diameter reel					

LINKS TO RELATED DOCUMENTS						
Dimensions	www.vishay.com/doc?96164					
Part marking information	www.vishay.com/doc?95444					
Packaging information	www.vishay.com/doc?96424					

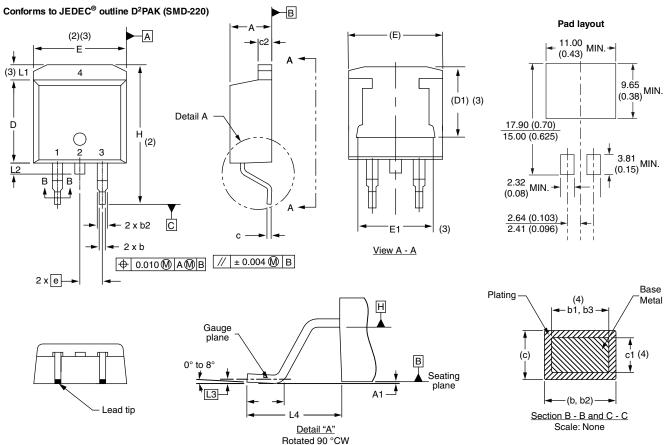
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D²PAK

DIMENSIONS in millimeters and inches

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<u>S</u>	cale	<u>ə:</u> 8	:1

SYMBOL	MILLIM	ETERS	INC	HES	NOTES
STINDUL	MIN.	MAX.	MIN.	MAX.	NOTES
А	4.06	4.83	0.160	0.190	
A1	0.00	0.254	0.000	0.010	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
С	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2

SYMBOL	MILLIM	ETERS	INC	NOTES	
STNIDUL	MIN.	MAX.	MIN.	MAX.	NOTES
D1	6.86	8.00	0.270	0.315	3
E	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
е	2.54	BSC	0.100	BSC	
Н	14.61	15.88	0.575	0.625	
L	1.78	2.79	0.070	0.110	
L1	-	1.65	-	0.066	3
L2	1.27	1.78	0.050	0.070	
L3	0.25 BSC		0.010	BSC	
L4	4.78	5.28	0.188	0.208	

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Notes

⁽¹⁾ Dimensioning and tolerancing per ASME Y14.5 M-1994

(2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body

(3) Thermal pad contour optional within dimension E, L1, D1 and E1

⁽⁴⁾ Dimension b1 and c1 apply to base metal only

(5) Datum A and B to be determined at datum plane H

Controlling dimension: inches (6)

⁽⁷⁾ Outline conforms to JEDEC[®] outline TO-263AB

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Document Number: 96164

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